Honorary Advisor The Honourable LEUNG Chun Ying, GBS, JP

Date: August 3 2009

The International Conference on Sustainable Integrated Design Process for Buildings and Construction (SIDP) Hong Kong 29th-30th September 2009 (SIDP 09)

Organised by
The Hong Kong Institute of Facility Management

Co-organised by
The University of Hong Kong (as Implementing Agent)
&
The Hong Kong Institute of Surveyors

Funded by
Commerce and Economic Development Bureau, The HKSAR Government

Dear Chairman or President of Professional Institution,

Invitation for Conference Participation

On behalf of the Organising Committee of the SIDP 09 Conference, I write to inform you of the upcoming HKIFM International Conference on Sustainable Integrated Design Process (SIDP) to be held on 29th – 30th September 2009 (Tuesday and Wednesday) at Joint Professional Centre, Hong Kong.

We would greatly treasure your help in disseminating our Conference flyer, and encouraging support and participation from your members, colleagues or other stakeholders of your esteemed organisation to this Conference. We attach herewith an e-flyer for your kind dissemination.

Should you have any queries, please contact the Conference Secretariat Ms. Ava Lau / Ms. Adela Au-Yeung at +852 2372-0090 or email: ava@creativegp.com / adela@creativegp.com.

Yours Sincerely,

Stephen CHUNG Wai Kit

President The HKIFM

cc. Organizing Committee for SIDP 09

Encl.

- Conference Flyer